

## **Call for Partners: The 3<sup>rd</sup> International Test Conference in Asia, 2019**

International Test Conference in Asia (ITC-Asia) is the Asian regional version of International Test Conference (ITC) which has been held in the United States. ITC has been a flagship conference on test technology of computer systems and semiconductor integrated circuits since 1970. With an attempt to stimulate more discussion around the globe, the 1st ITC-Asia was initiated in Taipei in 2017, and the 2nd ITC-Asia was held with great success in Harbin China in 2018. And this time, the 3rd ITC-Asia will be held in Tokyo, Japan in 2019. ITC / ITC-Asia aims not only to publish the results of academic research, but also as a place for presenting leading-edge technologies in the industry, as well as for academic and industrial interaction. We hope that you will take advantage of this great opportunity to partner (sponsor) and advertise your products, services and brand to a large audience of test technology specialists.

### **Conference overview**

Name: The 3<sup>rd</sup> International Test Conference in Asia, 2019

Dates: Tuesday, September 3, 2019 - Thursday, September 5

Venue: Tokyo Denki University

[Tokyo Senju Campus](#) Building No. 1 (Niwa Hall, Seminar room & etc.)

Participants: 150 - 200. 40% of participants will be from companies. (Prediction)

### **Tentative Conference schedule:**

**Day 1:** Tutorials (two themes, attendees expected to about 50)

**Day 2:** Opening / Keynote address / Invited talk (Niwa Hall)

Two regular paper tracks / One industry track (seminar rooms)

**Day 3:** Keynote address / Invited talk (Niwa Hall)

Two regular paper tracks / One industry track (seminar rooms)

**Other events on Day 2:** Banquet (Evening), Poster session & High school students' presentations (Lunch time and/or coffee break)

## Partnership:

- **Silver Partner**            100,000 yen / 1000 USD
- **Gold Partner**             200,000 yen / 2000 USD
- **Platinum Partner**       300,000 yen / 3000 USD or more

Other options are also available. For further detail, contact Industry Co-Chairs.  
Application form with payment information will be sent.

## Benefits of Partners:

- **Silver Partner**            Including one people's regular registration.
- **Gold Partner**             Including two people's regular registration.
- **Platinum Partner:**       Including two people's regular registration and Invited Talk.
- **For all partners,**
  1. Company names with logos are displayed on the web site, final program, and so on,
  2. Company leaflets can be distributed to the attendees on-site,
  3. Company activities can be presented at Industry Sessions, Poster Exhibitions and Demonstrations.

\* Events and items are available on a first-come, first-served basis.

## Co-Sponsors

IEEE Computer Society / TTTC (Test Technology Technical Council) (\*), IEEE Council on Electronic Design Society, Tokyo Denki University, Hiroshima City University, Kyushu Institute of Technology

\* Approval pending.

## Reference Information:

ITC Asia 2019    <http://www.itc-asia.info.hiroshima-cu.ac.jp/>

ITC-Asia 2018    <http://www.carch.ac.cn/ITC-Asia-2018/>

ITC-Asia 2017    <http://windy.ee.nthu.edu.tw/ITC-Asia-2017/HOME.html>

ITC                <http://www.itctestweek.org/>

## Contact Information:

Industry Co-chairs:

Shuji Hamada and Yoshiyuki Nakamura

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